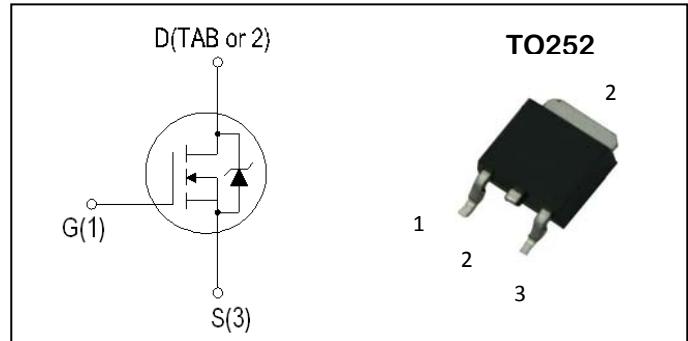


N-Channel Enhancement Mode Field Effect Transistor**PRODUCT SUMMARY**

| V_{DSS} | I_D | $R_{DS(ON)}$ ($m\Omega$) |
|-----------|-------|----------------------------|
| 60V | 46A | 18m Ω |

**Absolute Maximum Ratings ($T_A = 25^\circ C$ unless otherwise specified)**

| Symbol | Parameter | Ratings | Unit |
|-----------------------------------|---|----------------|------------|
| Common Ratings | | | |
| V_{DSS} | Drain-Source Voltage | 60 | V |
| V_{GSS} | Gate-Source Voltage | ± 20 | |
| T_J | Maximum Junction Temperature | 150 | $^\circ C$ |
| T_{STG} | Storage Temperature Range | -55 to 175 | $^\circ C$ |
| I_S | Diode Continuous Forward Current | TC=25°C 46 | A |
| Mounted on Large Heat Sink | | | |
| I_{DM} | 300 μs Pulse Drain Current Tested(1) | TC=25°C 183 | A |
| I_D | Continuous Drain Current | TC=25°C 46 | A |
| P_D | Maximum Power Dissipation | TC=25°C 75 | W |

1. Pulse width limited by maximum junction temperature.

Thermal Characteristics

| Symbol | Parameter | Ratings | Unit |
|------------|---|---------|--------------|
| R_{thJC} | Thermal resistance junction-case max | 2.0 | $^\circ C/W$ |
| R_{thJA} | Thermal resistance junction-ambient max | 40 | $^\circ C/W$ |

Electrical Characteristics (TA=25°C Unless Otherwise Noted)

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|----------------------------------|---|---|------|------|------|------|
| On/off Characteristics | | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | V _{GS} =0V, I _{DS} =250uA | 60 | -- | -- | V |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} = 48V, V _{GS} =0V | -- | -- | 1 | uA |
| | | V _{DS} =48V, V _{GS} =0V T _J =55°C | -- | -- | 5 | |
| V _{G(th)} | Gate Threshold Voltage | V _{DS} =V _{GS} , I _{DS} =250uA | 2 | -- | 4 | V |
| I _{GSS} | Gate Leakage Current | V _{GS} =±20V, V _{DS} =0V | -- | -- | ±100 | nA |
| R _{DSON} | Drain-SourceOn-stateResistance ⁽²⁾ | V _{GS} = 10V, I _{DS} =27A | -- | 16.0 | 18.0 | mΩ |
| g _{FS} | Forward transconductance ⁽²⁾ | V _{DS} = 10V, I _{DS} =27A | -- | 14 | -- | S |
| Dynamic Characteristics | | | | | | |
| C _{iss} | Input Capacitance | V _{GS} =0V, V _{DS} = 25V, Frequency=1.0MHz | -- | 999 | -- | pF |
| C _{oss} | Output Capacitance | | -- | 166 | -- | |
| C _{rss} | Reverse Transfer Capacitance | | -- | 67 | -- | |
| Switching Characteristics | | | | | | |
| t _{d(ON)} | Turn-on Delay Time ⁽¹⁾ | V _{DD} =30V, I _D = 23A, V _{GS} = 10V, R _{GEN} =10 Ω | -- | 9 | -- | ns |
| t _r | Turn-on Rise Time ⁽¹⁾ | | -- | 42 | -- | |
| t _{d(OFF)} | Turn-off Delay Time ⁽¹⁾ | | -- | 26 | -- | |
| t _f | Turn-off Fall Time ⁽¹⁾ | | -- | 7 | -- | |
| Q _g | Total Gate Charge ⁽¹⁾ | V _{DS} =30V, V _{GS} = 10V, I _{DS} =46A | -- | 18 | -- | nC |
| Q _{gs} | Gate-Source Charge ⁽¹⁾ | | -- | 7 | -- | |
| Q _{gd} | Gate-Drain Charge ⁽¹⁾ | | -- | 4 | -- | |
| Diode Characteristics | | | | | | |
| V _{SD} | Diode Forward Voltage ⁽²⁾ | I _{SD} = 1A, V _{GS} = 0 | -- | -- | 1.2 | V |
| t _{rr} | Reverse Recovery Time | I _{SD} =23A, dI _{SD} /dt=50A/μs | -- | 42.0 | -- | ns |
| q _{rr} | Reverse Recovery Charge | | -- | 31.0 | -- | nC |

NOTES:

- Independent of operating temperature.
- Pulse Test : Pulse width \leqslant 300 μ s, Duty cycle \leqslant 2%

Typical Performance Characteristics

Figure 1: On-Region Characteristics

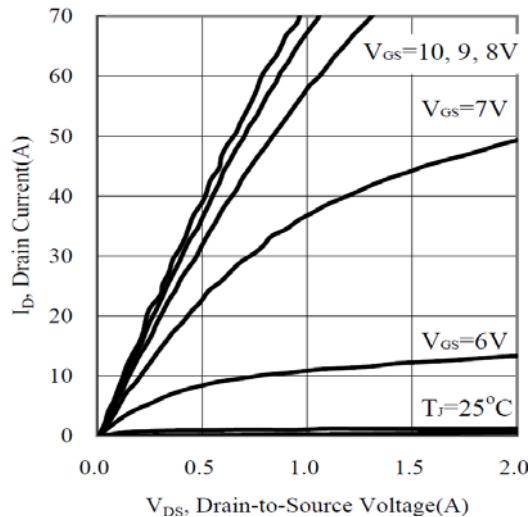


Figure 2: Power Dissipation

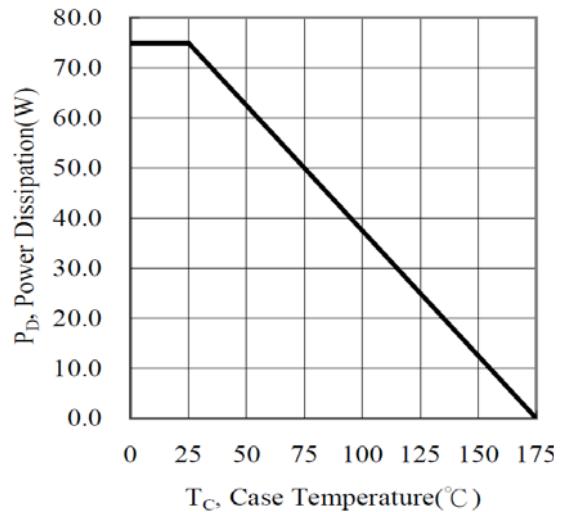


Figure 3: Drain Current

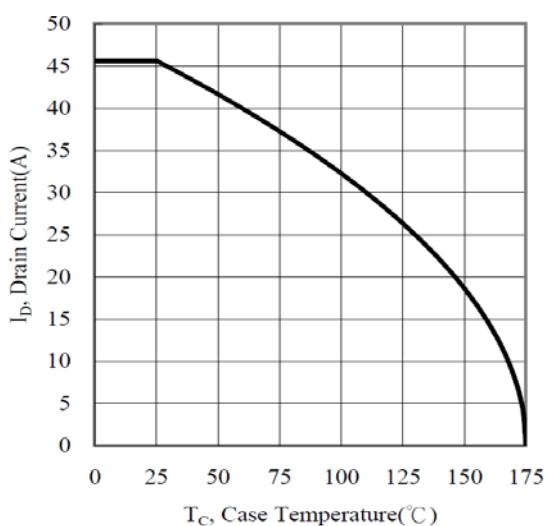


Figure 4: Drain-to-Source Breakdown Voltage

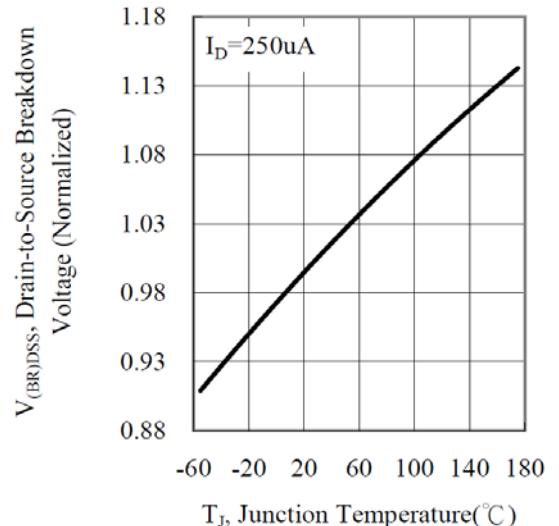


Figure 5: Capacitance Characteristics

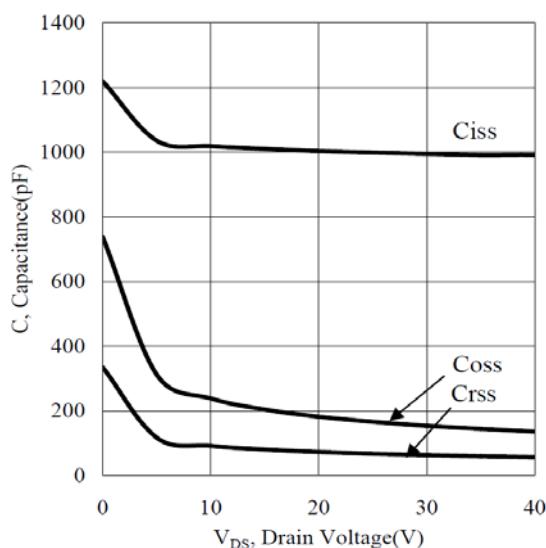


Figure 6: Gate Charge Characteristics

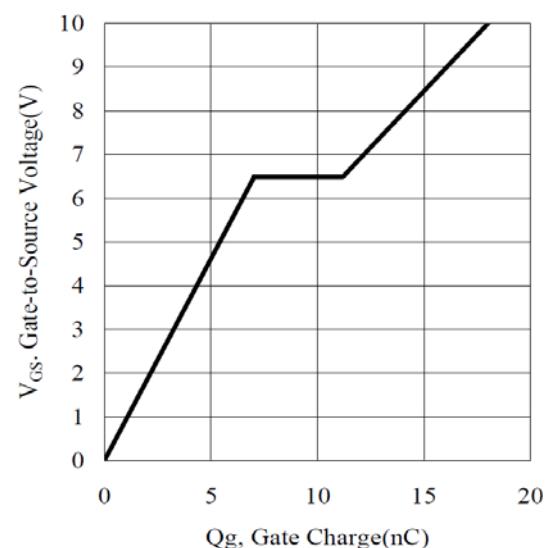
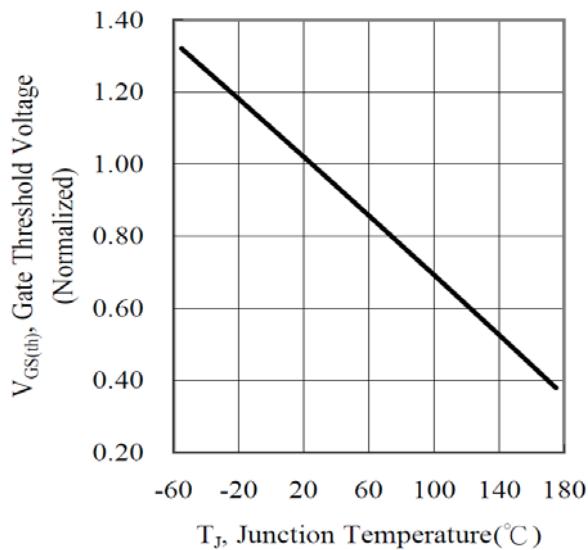
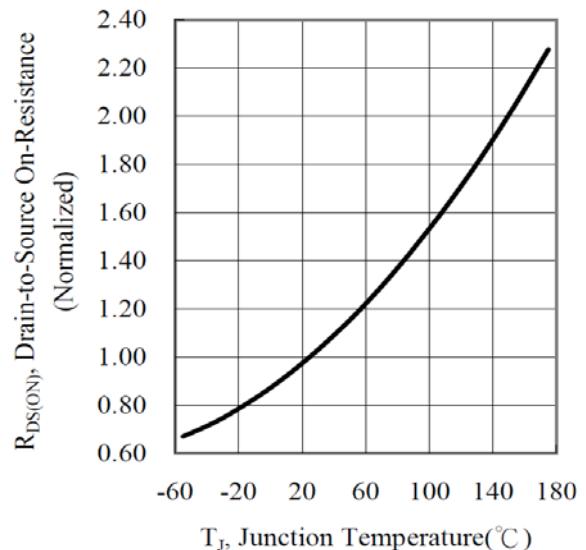
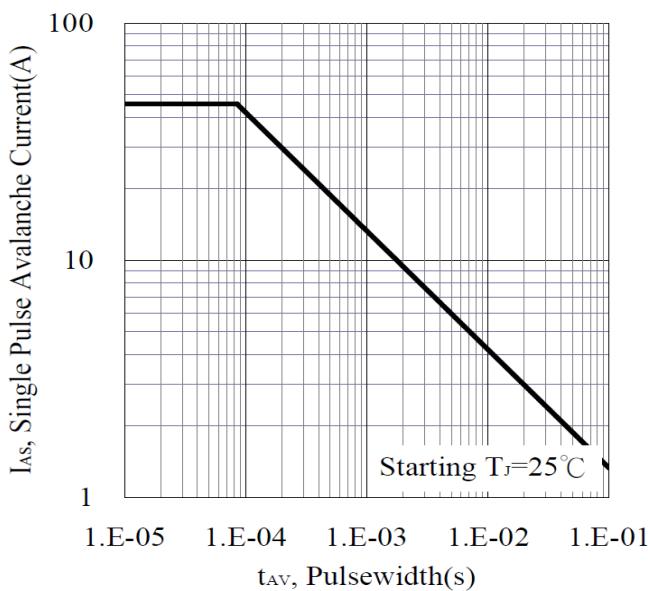
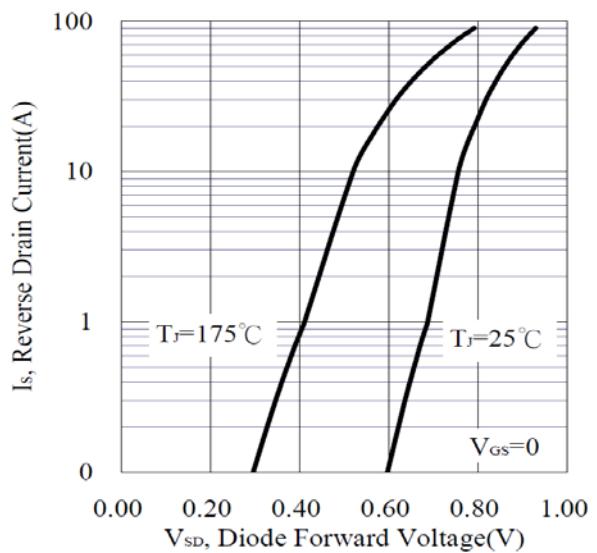
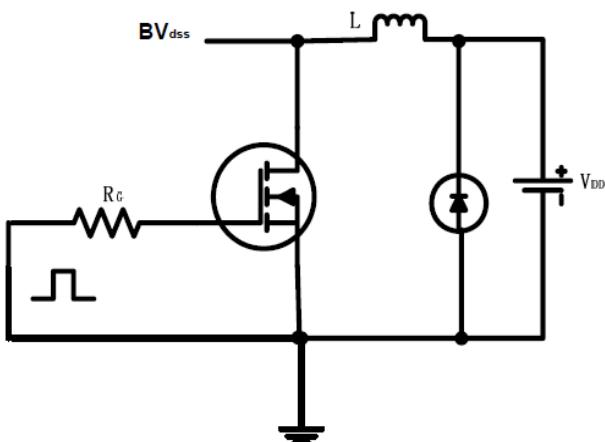


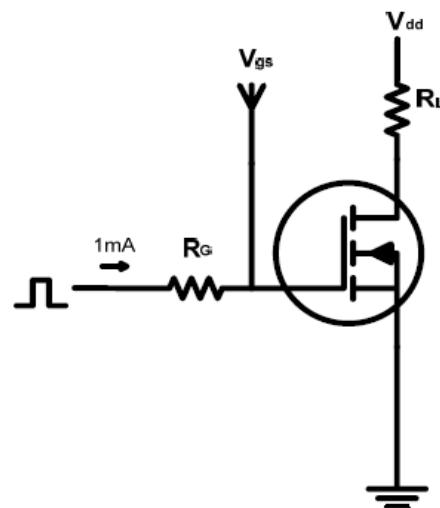
Figure 7: Gate Threshold Voltage**Figure 8: Drain-to-Source On-Resistance****Figure 9: Avalanche Characteristics****Figure 10: Forward Characteristics of reverse diode**

Test circuits and Waveforms

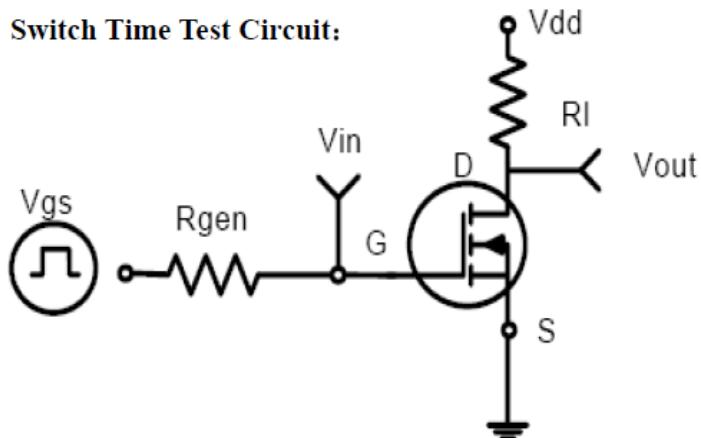
EAS test circuits:



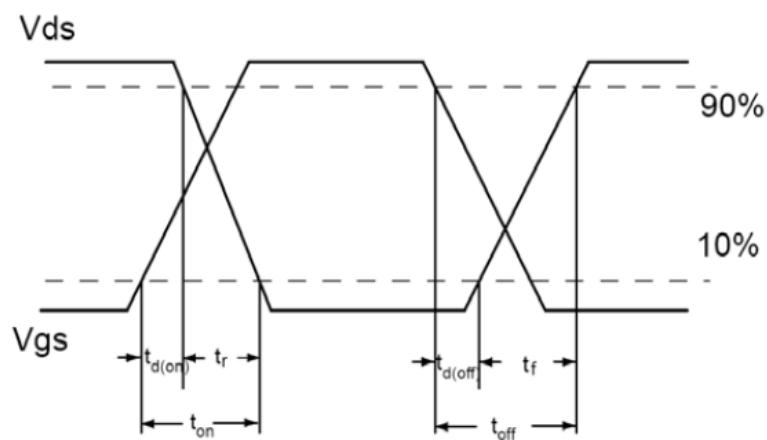
Gate charge test circuit:



Switch Time Test Circuit:

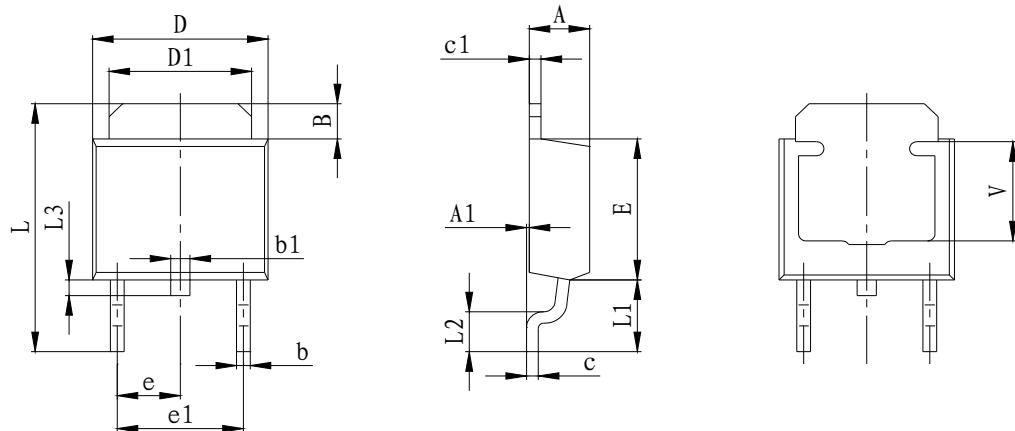


Switch Waveforms:



PACKAGE MECHANICAL DATA

TO-252 Package Dimension



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min. | Max. | Min. | Max. |
| A | 2.200 | 2.400 | 0.087 | 0.094 |
| A1 | 0.000 | 0.127 | 0.000 | 0.005 |
| B | 1.350 | 1.650 | 0.053 | 0.065 |
| b | 0.500 | 0.700 | 0.020 | 0.028 |
| b1 | 0.700 | 0.900 | 0.028 | 0.035 |
| c | 0.430 | 0.580 | 0.017 | 0.023 |
| c1 | 0.430 | 0.580 | 0.017 | 0.023 |
| D | 6.350 | 6.650 | 0.250 | 0.262 |
| D1 | 5.200 | 5.400 | 0.205 | 0.213 |
| E | 5.400 | 5.700 | 0.213 | 0.224 |
| e | 2.300 TYP. | | 0.091 TYP. | |
| e1 | 4.500 | 4.700 | 0.177 | 0.185 |
| L | 9.500 | 9.900 | 0.374 | 0.390 |
| L1 | 2.550 | 2.900 | 0.100 | 0.114 |
| L2 | 1.400 | 1.780 | 0.055 | 0.070 |
| L3 | 0.600 | 0.900 | 0.024 | 0.035 |
| V | 3.800 REF. | | 0.150 REF. | |